January 2004

FDC6036P

FAIRCHILE

P-Channel 1.8V Specified PowerTrench[®] MOSFET

General Description

This dual P-Channel 1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. Packaged in FLMP SSOT-6, the $R_{DS(ON)}$ and thermal properties of the device are optimized for battery power management applications.

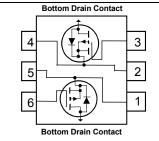
Applications

- Battery management/Charger Application
- Load switch

Features

- -5 A, -20 V. $R_{DS(ON)} = 44 \text{ m}\Omega \textcircled{0} V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 64 \text{ m}\Omega \textcircled{0} V_{GS} = -2.5 \text{ V}$ $R_{DS(ON)} = 95 \text{ m}\Omega \textcircled{0} V_{GS} = -1.8 \text{ V}$
- Low gate charge, High Power and Current handling capability
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- FLMP SSOT-6 package: Enhanced thermal performance in industry-standard package size



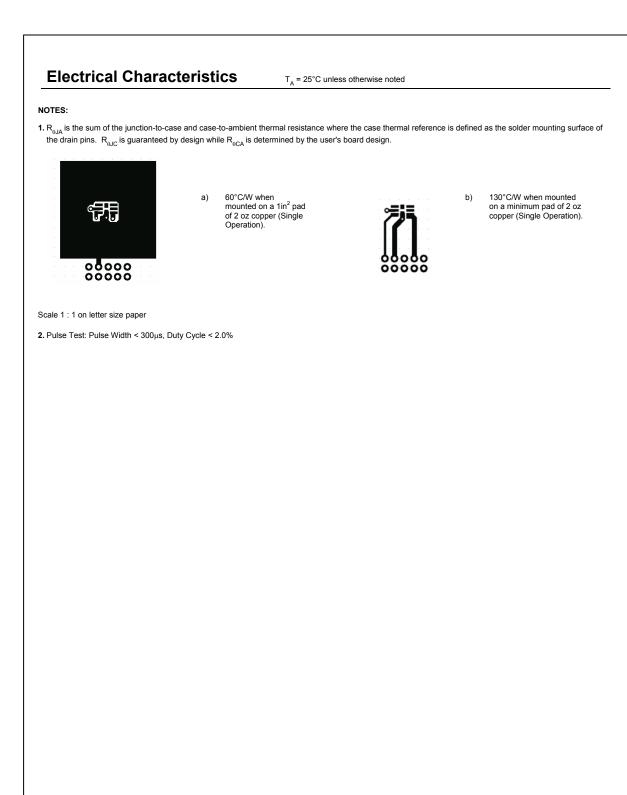


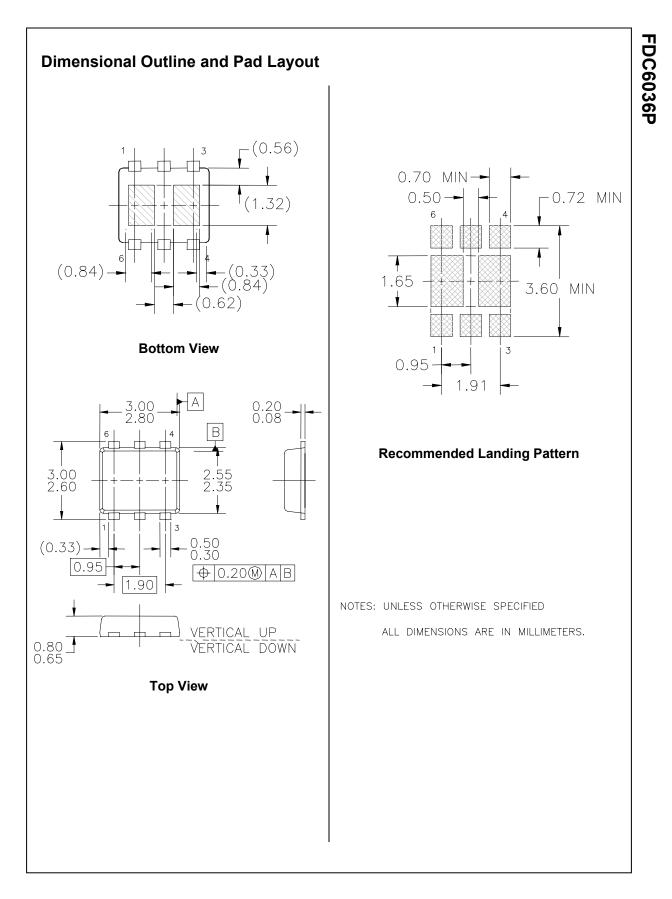
MOSFET Maximum Ratings TA=25°C unless otherwise noted

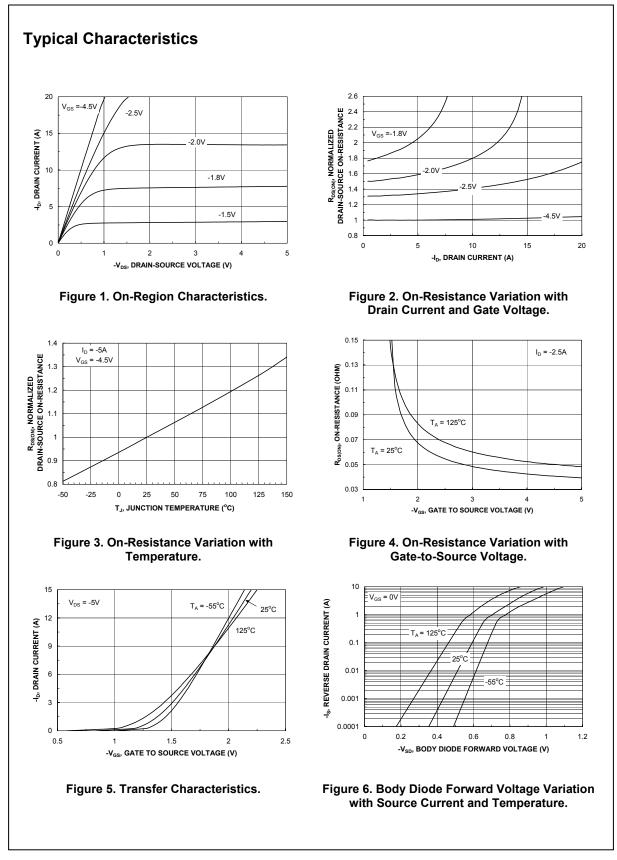
Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
I _D	Drain Current – Continuous	(Note 1a)	-5	А
	– Pulsed		-20	
P _D Power Dissipation for Dual Operation			1.8	W
	Power Dissipation for Single Operation	(Note 1a)	1.8	
		(Note 1b)	0.9	
T _J , T _{stg}	Operating and Storage Junction Tempera	ature Range	-55 to +150	°C
Therma	al Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		68	°C/W
R _{0JC}	Thermal Resistance, Junction-to-Case		1	
	e Marking and Ordering Inf	ormation		
.036	FDC6036P	7"	8mm	3000 units

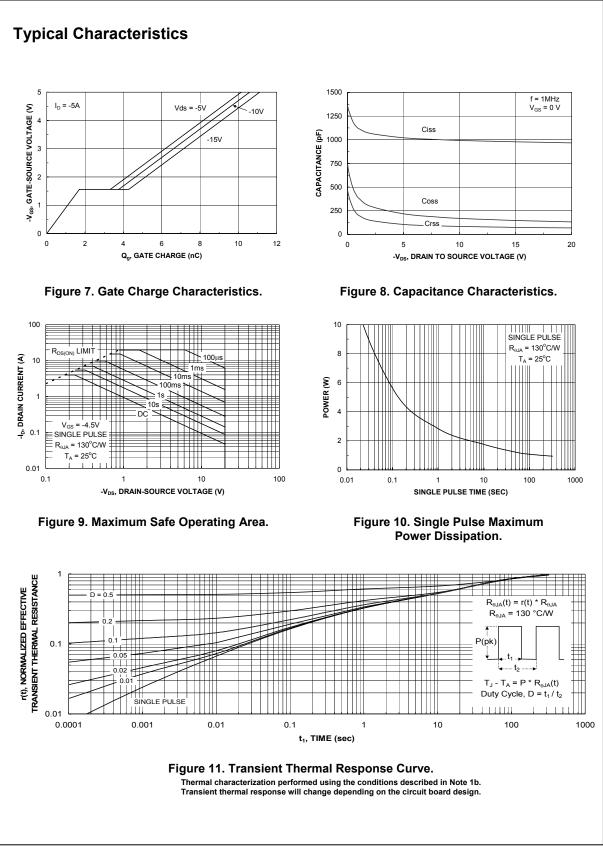
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source BreakdownVoltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-20			V
<u>ΔBVdss</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = –250 µA, Referenced to 25°C		-24		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -16 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μA
I _{GSS}	Gate–Body Leakage	$V_{GS} = \pm 8 V$, $V_{DS} = 0 V$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-0.7	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = –250 μ A, Referenced to 25°C		4.4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, \qquad I_D = -5.0 \ A \\ V_{GS} = -2.5 \ V, \qquad I_D = -4.0 \ A \\ V_{GS} = -1.8 \ V, \qquad I_D = -3.2 \ A \\ V_{GS} = -4.5 \ V, I_D = -5 \ A, T_J = 125^\circ C \end{array} $		37 52 74 51	44 64 95 61	mΩ
gfs	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -5 A$		16		S
Dynamic	Characteristics					•
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		992		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		169		pF
C _{rss}	Reverse Transfer Capacitance			85		pF
Rg	Gate Resistance	V _{GS} = 15 mV f = 1.0 MHz		8.6		mΩ
Switchin	g Characteristics (Note 2)				•	
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -10 V$, $I_D = -1 A$,		12	24	ns
tr	Turn–On Rise Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω		10	20	ns
$t_{d(off)}$	Turn–Off Delay Time			40	64	ns
t _f	Turn–Off Fall Time			20	36	ns
Q _g	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -5 A$,		10	14	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -4.5 V		1.7		nC
Q _{gd}	Gate-Drain Charge			2.0		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings			•	•
ls	Maximum Continuous Drain-Sour	ce Diode Forward Current			-1.25	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -1.25 A$ (Note 2)		-0.7	-1.2	V
trr	Diode Reverse Recovery Time	I _F = –5 A,		19		ns
Qrr	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		7.8		nC









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